

DATA SHEET

# AWB7238: 791 to 821 MHz Small-Cell Power Amplifier Module

## Applications

- LTE, WCDMA and HSDPA air interfaces
- Picocell, femtocell, home nodes
- Customer premises equipment

## Features

- InGaP HBT technology
- -47 dBc ACPR @  $\pm 10$  MHz, +27 dBm
- 30 dB gain
- High efficiency
- Low transistor junction temperature
- Matched for a 50  $\Omega$  system
- Low profile miniature surface-mount package; RoHS compliant
- Multi-carrier capability
- Surface-mount (14-pin, 7 x 7 x 1.3 mm) package (MSL4, 260 °C per JEDEC J-STD-020)



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## Description

The AWB7238 is a fully matched, Multi-Chip-Module (MCM) designed for picocell, femtocell, and customer premises equipment (CPE) applications. Consisting of two parallel-path high-linearity, high-efficiency power amplifiers, the device meets the extremely demanding needs of small cell infrastructure architectures. Designed for LTE, WCDMA, and HSDPA air interfaces operating in the 791 to 821 MHz bands, the AWB7238 delivers up to +27 dBm of LTE (E-TM1.1) power through an external 90° hybrid coupler with an ACPR of -47 dBc. The device operates from a convenient +4.5 V supply and provides 30 dB of gain.

The device is manufactured using an advanced InGaP HBT MMIC technology offering state-of-the-art reliability, temperature stability, and ruggedness. The self-contained 7 x 7 x 1.3 mm surface-mount package incorporates RF matching networks optimized for output power, efficiency, and linearity in a 50  $\Omega$  system.

A block diagram of the AWB7238 is shown in Figure 1. The device package and pinout are shown in Figure 2. Signal pin assignments and functional pin descriptions are described in Table 1.

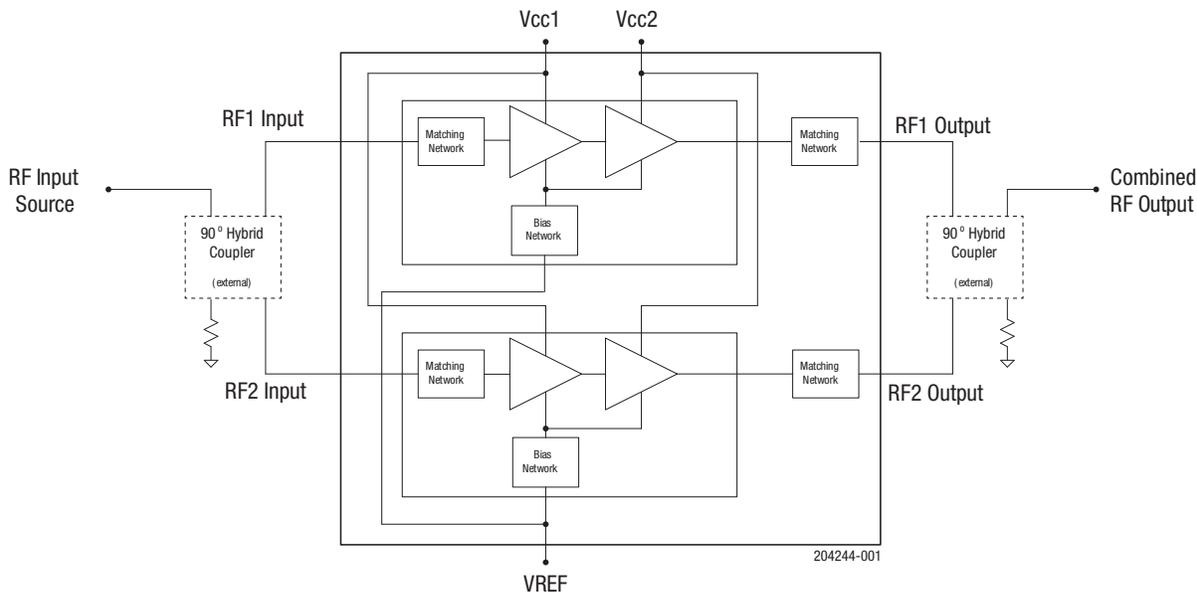


Figure 1. AWB7238 Block Diagram

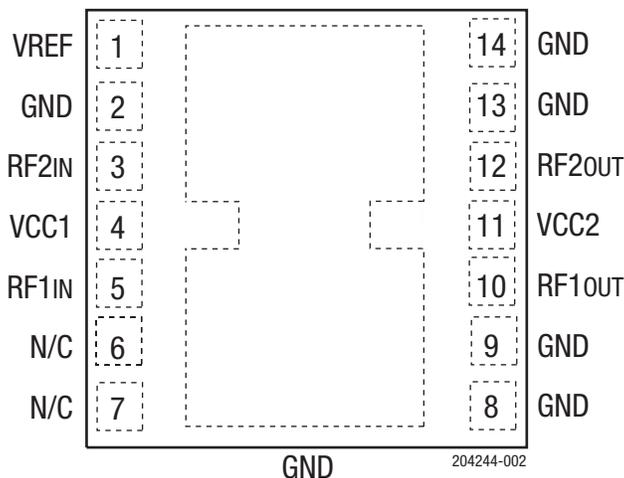


Figure 2. AWB7238 Pinout (Top View)

Table 1. AWB7124 Signal Pin Descriptions

Pin	Name	Description	Pin	Name	Description
1	VREF	Reference voltage	8	GND	Ground
2	GND	Ground	9	GND	Ground
3	RF2IN	RF2 input	10	RF1OUT	RF1 output
4	VCC1	Supply voltage	11	VCC2	Supply voltage
5	RF1IN	RF1 input	12	RF2OUT	RF2 output
6	N/C	No connection	13	GND	Ground
7	N/C	No connection	14	GND	Ground

## Electrical and Mechanical Specifications

The absolute maximum ratings of the AWB7238 are provided in Table 2. Recommended operating conditions are specified in Table 3, and electrical specifications are provided in Table 4.

**Table 2. AWB7238 Absolute Maximum Ratings<sup>1</sup>**

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage	V <sub>CC</sub>		+5	V
Reference voltage	V <sub>REF</sub>		+3.5	V
RF output power <sup>2</sup>	P <sub>OUT</sub>		+30	dBm, modulated
RF input power	P <sub>IN</sub>		+10	dBm, CW
Electrostatic discharge: Human Body Model, Class 1C <sup>3</sup> Charged Device Model, Class 4 <sup>4</sup>	ESD		2000 >1000	V V
Junction temperature	T <sub>J</sub>		+150	°C
Storage temperature	T <sub>STG</sub>	-40	+150	°C

<sup>1</sup> Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

<sup>2</sup> At output of external 90 hybrid coupler.

<sup>3</sup> JEDEC JS-001-2010.

<sup>4</sup> JEDEC JESD22-C101D.

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**ESD HANDLING:** *Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.*

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**Table 3. AWB7238 Recommended Operating Conditions<sup>1</sup>**

Parameter	Symbol	Min	Typ	Max	Units
Operating frequency	f	791		821	MHz
Supply voltage	V <sub>CC</sub>	+3.6	+4.5	+4.65	V
Reference voltage:					
PA on	V <sub>REF</sub>	+2.80	+2.85	+2.90	V
PA off		0		+0.5	V
RF output power <sup>2</sup>	P <sub>OUT</sub>		+27		dBm
Case temperature <sup>3</sup>	T <sub>C</sub>	-40		+85	°C

<sup>1</sup> The device may be operated safely over these conditions; however, parametric performance is guaranteed only over the conditions defined in the electrical specifications.

<sup>2</sup> Typ RF Output Power is used during production test.

<sup>3</sup> Case Temperature references the board temperature at the ground paddle on the backside of the package.

**Table 4. AWB7238 Electrical Specifications<sup>1</sup>**  
 (T<sub>C</sub> = +25 °C, V<sub>CC</sub> = +4.5 V, V<sub>REF</sub> = +2.85 V, 50 Ω system)

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Gain <sup>2</sup>	G		27	30	35	dB
ACPR: <sup>1,2,3</sup> @ 10 MHz @ 20 MHz				-48 -57	-45 -54	dBc dBc
Power-added efficiency <sup>1,2,3</sup>			12	14		%
Thermal resistance	R <sub>Jc</sub>	Junction to case		13		°C/W
Supply current <sup>1,2,3</sup>	V <sub>CC</sub>	Total through VCC pins		795	925	mA
Quiescent current	I <sub>cq</sub>		200	295	375	mA
Reference current		Through VREF pin	7.5	10	12.5	mA
Leakage current		V <sub>CC</sub> = +5 V, V <sub>REF</sub> = 0 V		3	10	uA
Harmonics: 2fo 3fo 4fo				-55 -65 -65	-45 -50 50	dBc dBc dBc
Input return loss			15	20		dB
Output return loss			15	20		dBm
P1dB		CW tone		+35.5		dBm
Spurious output level (all spurious outputs)		P <sub>OUT</sub> ≤ +27 dBm, in-band load VSWR < 5:1, Out-of-band load VSWR < 10:1, applies over all voltage and temperature operating ranges			-60	dBc
Load mismatch stress with no permanent degradation or failure		V <sub>CC</sub> = +4.5 V, P <sub>OUT</sub> = +27 dBm Applies over full operating temperature range	8:1			VSWR

<sup>1</sup> ACPR and efficiency measured at 806 MHz.

<sup>2</sup> P<sub>OUT</sub> = +27 dBm.

<sup>3</sup> E-TM1.1 LTE 10 MHz.

### Evaluation Board Description

The AWB7238 Evaluation Board is used to test the performance of the AWB7238 device. A schematic of a typical application circuit is shown in Figure 3.

### Shutdown Mode

The power amplifier can be placed in shutdown mode by applying logic low levels (see Table 3) to the V<sub>REF</sub> voltage.

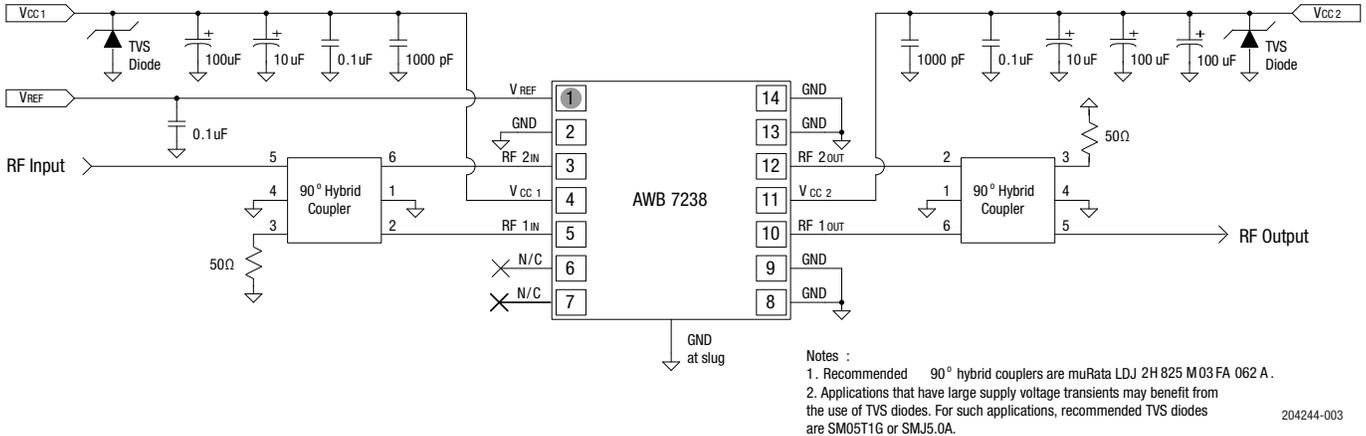


Figure 3. AWB7238 Application Circuit Schematic

### Package Dimensions

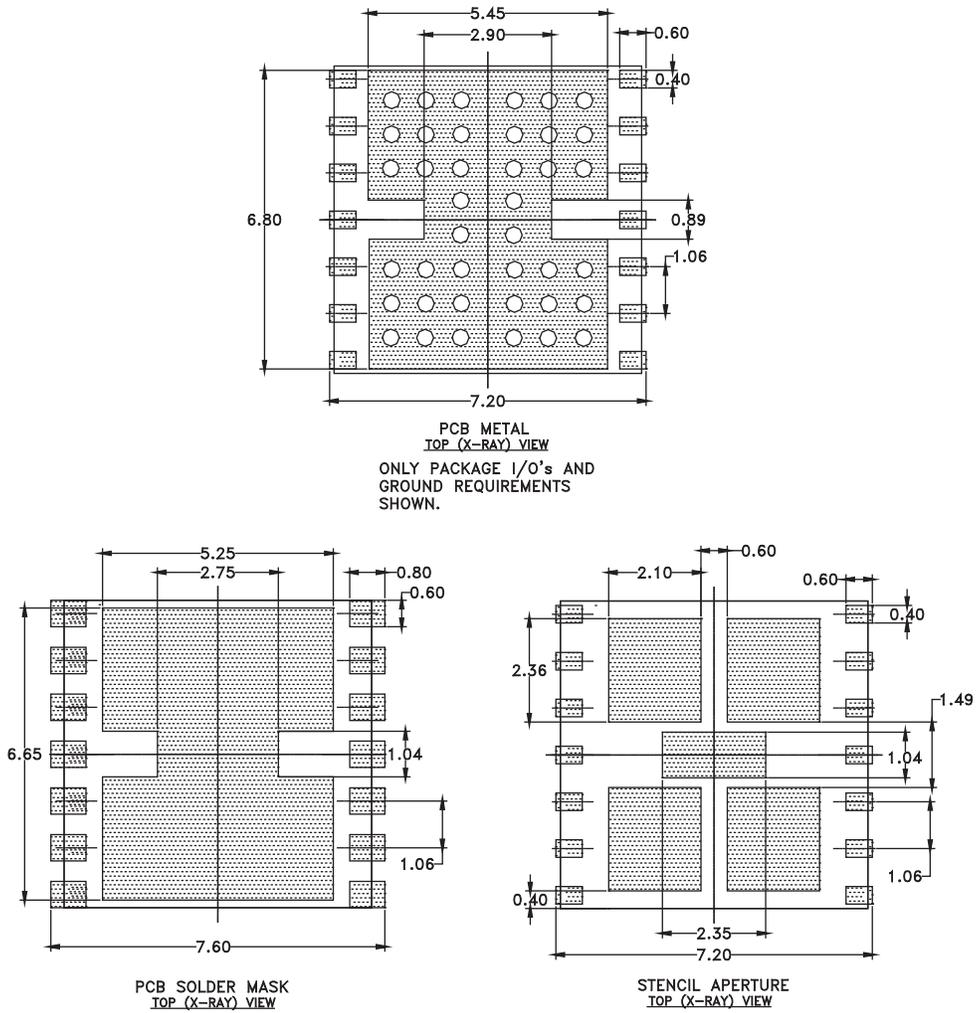
The PCB layout footprint drawing for the AWB7238 is shown in Figure 4. Typical part markings are shown in Figure 5. The package dimensions for the AWB7238 are shown in Figure 6. The tape and reel dimensions are provided in Figure 7.

### Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The AWB7238 is rated to Moisture Sensitivity Level 4 (MSL4) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



Notes:

1. Unless specified, dimensions are symmetrical about center lines shown.
2. Dimensions are in millimeters.
3. Vias shown in PCB Metal View are for reference only. Number and size of thermal vias required are dependent on heat dissipation requirements and the PCB process capability.

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**Figure 4. AWB7238 PCB Layout Footprint Dimensions**

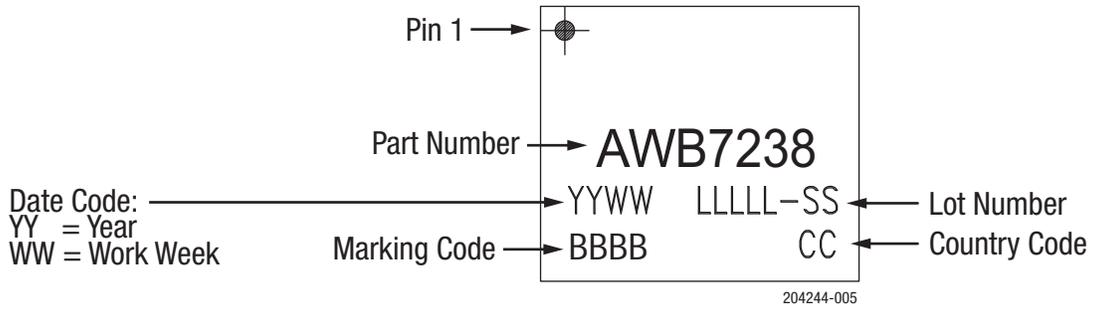
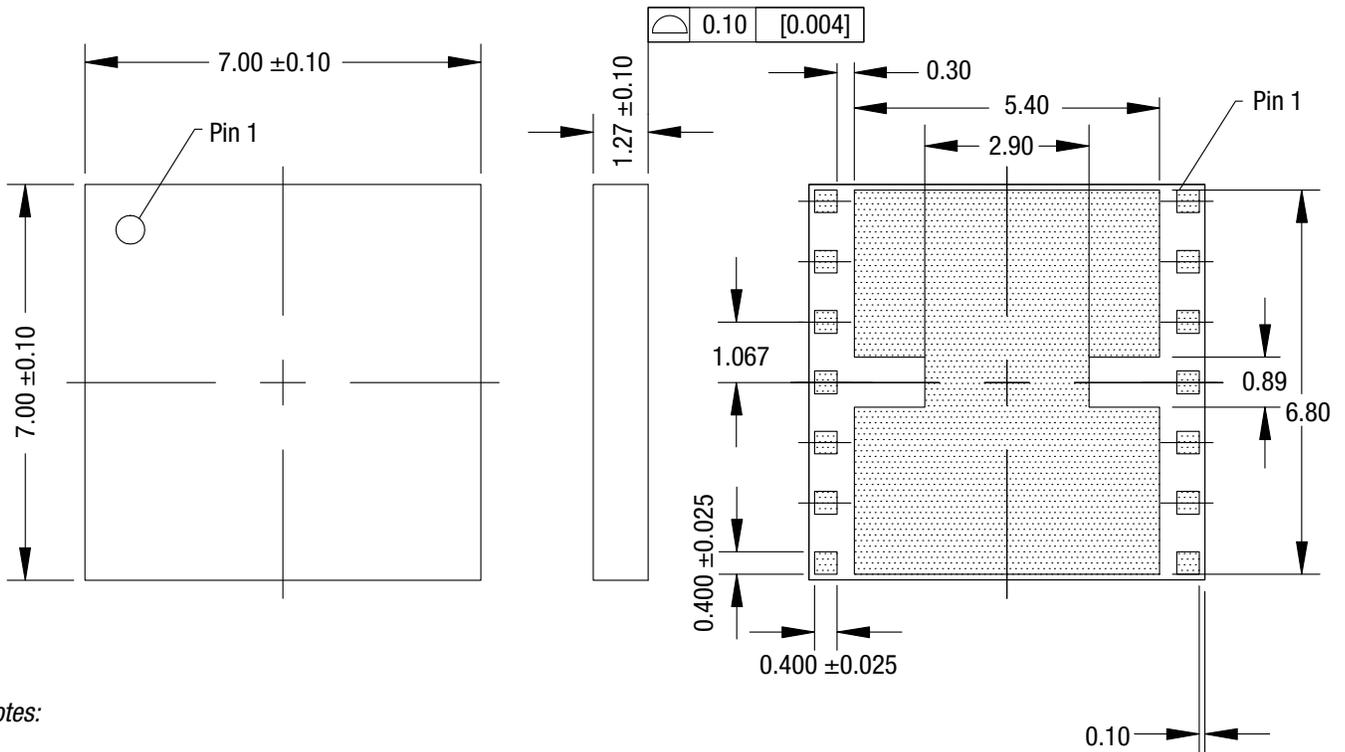


Figure 5. AWB7238 Typical Part Marking



Notes:

1. All dimensions are in millimeters.
2. Unless specified otherwise, tolerance =  $\pm 0.076$  [0.003].
3. Pads (including center) are shown as uniform size for reference only.  
Actual pad size and location will vary within the minimum and maximum dimensions according to the specific laminate design.

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Figure 6. AWB7238 Package Dimensions



## Ordering Information

Model Number	Package Description	Component Packaging
AWB7238P8	RoHS-compliant 14-pin 7 x 7 x 1.3 mm surface-mount module	2500-piece tape and reel
EVB7238		Evaluation Board part number

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